

1 Products affected

Product hierarchy no. *		Part no.	SBU	Type / Description	Customer part no.
SBU PG PC	GU Type				
01 002 0	30 0000000522	0031.8263 0031.8264 0031.8265 0031.8273 0031.8274 0031.8275 0031.8263.W 0031.8265.W 0031.8273.W 0031.8275.W 0031.8275.W 0031.9001	Circuit Protection	OGN-SMD	

*SBU (2-digit) / PG (3-digit) / PGU (3-digit) / Type (10-digit)

2 Type of change

Product improvement, change of material.

3 Detailed description of change

Change to a new thermoplastic material with a slightly different color shade

4 Reason of change

Changes on the OGN-SMD fuseholders to meet the enhanced reflow-soldering requirements.

5 Release date

The change came into effect on January 1st 2014 (date code 1401 or higher on label).

6 Impact of change and recommended action

No influence (change of material and different color shade only)
No influence
No influence
No influence
No influence

7 Reference Documents / Attachments

Kind of document	Document number	Remarks
Datasheet	OGN-SMD	Web Link OGN-SMD

OGN-SMD						2207
creation date	created by	release date	released by	notification no.	revision	page
2014-01-30	arnetja	2014-02-06	dislercy	25752	b	1 of 1